

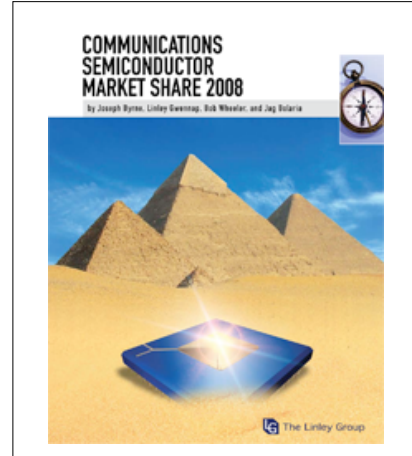
Communications Semiconductor Market Share 2008

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Authors: Joseph Byrne, Linley Gwennap, Bob Wheeler, and Jag Bolaria

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The Linley Group
Phone: 408-281-1947
Fax: 650-745-1490
Email: cs@linleygroup.com
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By Joseph Byrne, Linley Gwennap, Bob Wheeler and Jag Bolaria



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355 Chesley Avenue
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1-800-413-2881 or 408-281-1947
fax: 650-745-1490
email: cs@linleygroup.com
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About the Authors

Joseph Byrne



Joseph Byrne is a senior analyst at The Linley Group. With more than 15 years of industry experience, he is one of the industry's leading analysts covering the semiconductor market. He has published numerous reports analyzing various segments of the industry and is the coauthor of *A Guide to Next-Generation Wireless*. Joe has spoken at several investor forums and industry conferences, including Communication Design Conference, Network System Design Conference, Gartner Semiconductor Conference, Selby Venture Partners' LP Conference, and the BusinessWeek IT Symposium at Comdex. He has frequently been quoted in both technical and business publications, including *EE Times*, *Unstrung*, *Electronic Business*, the *San Jose Mercury News*, NewsFactor Network, and the wire services.

Before joining The Linley Group, Joe served as a principal analyst for semiconductors at Gartner Research. In this role, he was responsible for tracking technology trends and market size, preparing market forecasts, and assessing the competitive landscape. His expertise also includes evaluating business and strategic plans, advising startups and major IC suppliers on marketing and positioning strategies, and providing insight to VCs and investment banks to support investment decisions.

Joe led Gartner's coverage of networking semiconductors in the era of the telecom boom and bust. Thereafter, he led Gartner's coverage of computing semiconductors, including microprocessors, system-logic chip sets, and graphics processors. Through both eras, he led coverage of wireless LAN chip sets. Joe also authored Gartner's seminal report on digital-camera technology, and he covered embedded microprocessors in the late 1990s. Before serving as an analyst, Joe held consulting positions with Gartner, Deloitte Consulting, and smaller firms in the U.S. and Europe.

He began his career as a microprocessor designer for SMOS Systems, where he honed his technical skills as a principal engineer. He earned a bachelor of science degree in electrical engineering and computer science from Duke University and an MBA from the University of Michigan.

Linley Gwennap



Founder and principal analyst of The Linley Group, Linley Gwennap is one of the most respected analysts in the microprocessor industry. Before founding his company in 1999, Linley served as publisher and editorial director of *Microprocessor Report*, leading the top independent technology-analysis team in the microprocessor industry. He also spent eight years working on RISC systems and CPUs at Hewlett-Packard as a design engineer and product marketing manager. He graduated *cum laude* from Yale University with a bachelor of science degree in electrical engineering.

Bob Wheeler



Bob Wheeler is The Linley Group's senior analyst for networking silicon. An industry analyst and consultant since 1997, he is coauthor of *A Guide to Network Processors*, *A Guide to Next-Generation Wireless*, and *A Guide to Gigabit Ethernet Silicon*. Before 1997, Bob was division marketing manager for the Network Products Division of AMD. He was responsible for marketing local-area network (LAN) products, including Ethernet and wireless LAN controllers and transceivers. Bob spent the early part of his career as a software engineer, including seven years at microcomputer pioneer North Star Computers.

Jag Bolaria



Jag Bolaria is a senior analyst at The Linley Group, where he has coauthored *A Guide to Switch Fabrics*, *A Guide to Next-Generation Sonet Silicon*, and *A Guide to High-Speed Interconnect*. His extensive industry experience includes senior roles in both marketing and engineering. Before joining The Linley Group, Jag was the director of network systems and validation for Intel's Ethernet components. Prior to that, Jag was in Intel's PC division as director of marketing for chip sets. Jag started his career as an R&D engineer with Standard Telecom Labs (STL) after earning a bachelor of science degree in electronics, with honors, from the University of Salford in the U.K.

About the Publisher

The Linley Group

The Linley Group is the leading vendor of technology analysis on networking, communications, and consumer-electronics semiconductors, providing a unique combination of technical expertise and market knowledge. We help clients understand the market for these devices, their product requirements, the choices available, and which ones are best for a particular application.

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- Helping an established semiconductor vendor with messaging and positioning for an upcoming product launch
- Assisting an equipment vendor to select key components that are most appropriate for its application
- Providing valuable insights and technical due diligence to an investment group evaluating whether to invest in a semiconductor company

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The Linley Group
355 Chesley Avenue
Mountain View, California 94040

1-800-413-2881 or 408-281-1947
fax: 650-745-1490

email: cs@linleygroup.com
www.linleygroup.com